The HIP4081A is a high frequency, medium voltage Full Bridge N-Channel FET driver IC, available in 20 lead plastic SOIC and DIP packages. The HIP4081A can drive every possible switch combination except those which would cause a shoot-through condition. The HIP4081A can switch at frequencies up to 1 MHz and is well suited to driving Voice Coil Motors, high-frequency switching power amplifiers, and power supplies.

For example, the HIP4081A can drive medium voltage brush motors, and two HIP4081As can be used to drive high performance stepper motors, since the short minimum "on-time" can provide fine micro-stepping capability.

Short propagation delays of approximately 55 ns maximizes control loop crossover frequencies and dead-times which can be adjusted to near zero to minimize distortion, resulting in rapid, precise control of the driven load.

A similar part, the HIP4080A, includes an on-chip input comparator to create a PWM signal from an external triangle wave and to facilitate "hysteresis mode" switching.
The Application Note for the HIP4081A is the AN9405.

## Ordering Information

| PART <br> NUMBER | TEMP <br> RANGE <br> $\left({ }^{\circ} \mathrm{C}\right)$ | PACKAGE | PKG. <br> DWG. \# |
| :--- | :--- | :--- | :--- |
| HIP4081AIP (No longer <br> available, recommended <br> replacement: HIP4081AIPZ) | -40 to 85 | 20 Ld PDIP | E20.3 |
| HIP4081AIPZ (Note) | -40 to 85 | 20 Ld PDIP <br> (Pb-free) | E20.3 |
| HIP4081AIB | -40 to 85 | 20 Ld SOIC (W) | M20.3 |
| HIP4081AIBZ (Note) | -40 to 85 | 20 Ld SOIC (W) <br> (Pb-free) | M20.3 |

NOTE: Intersil Pb-free products employ special Pb-free material sets; molding compounds/die attach materials and 100\% matte tin plate termination finish, which is compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb -free requirements of IPC/JEDEC J Std-020B.

## Features

- Independently Drives 4 N-Channel FET in Half Bridge or Full Bridge Configurations
- Bootstrap Supply Max Voltage to $95 \mathrm{~V}_{\mathrm{DC}}$
- Drives 1000 pF Load at 1 MHz in Free Air at $50^{\circ} \mathrm{C}$ with Rise and Fall Times of Typically 10ns
- User-Programmable Dead Time
- On-Chip Charge-Pump and Bootstrap Upper Bias Supplies
- DIS (Disable) Overrides Input Control
- Input Logic Thresholds Compatible with 5V to 15V Logic Levels
- Very Low Power Consumption
- Undervoltage Protection
- Pb-free Available


## Applications

- Medium/Large Voice Coil Motors
- Full Bridge Power Supplies
- Switching Power Amplifiers
- High Performance Motor Controls
- Noise Cancellation Systems
- Battery Powered Vehicles
- Peripherals
- U.P.S.


## Pinout



## Application Block Diagram



Functional Block Diagram (1/2 HIP4081A)


## Typical Application (PWM Mode Switching)



## Absolute Maximum Ratings

 Logic I/O Voltages . . . . . . . . . . . . . . . . . . . . . . . -0.3 V to $\mathrm{V}_{\mathrm{DD}}+0.3 \mathrm{~V}$ Voltage on AHS, BHS . . -6.0V (Transient) to $80 \mathrm{~V}\left(25^{\circ} \mathrm{C}\right.$ to $\left.125^{\circ} \mathrm{C}\right)$ Voltage on AHS, BHS . . -6.0V (Transient) to $70 \mathrm{~V}\left(-55^{\circ} \mathrm{C}\right.$ to $\left.125^{\circ} \mathrm{C}\right)$ Voltage on ALS, BLS . . . . . . - 2.0 V (Transient) to +2.0 V (Transient) Voltage on AHB, BHB $\ldots \ldots . \mathrm{V}_{\text {AHS }}$, BHS -0.3 V to $\mathrm{V}_{\mathrm{AHS}}$, BHS $+\mathrm{V}_{\mathrm{DD}}$ Voltage on ALO, BLO .............. $\mathrm{V}_{\mathrm{ALS}, \mathrm{BLS}}-0.3 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}$ Voltage on AHO , $\mathrm{BHO} \ldots . . \mathrm{V}_{\mathrm{AHS}}$, BHS -0.3 V to $\mathrm{V}_{\mathrm{AHB}}$, BHB +0.3 V Input Current, HDEL and LDEL . . . . . . . . . . . . . . . . . . . -5 mA to 0 mA Phase Slew Rate . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 20V/ns NOTE: All Voltages relative to $\mathrm{V}_{\mathrm{SS}}$, unless otherwise specified.
Operating Conditions
Supply Voltage, $\mathrm{V}_{\mathrm{DD}}$ and $\mathrm{V}_{\mathrm{CC}} \ldots \ldots . . . . . . . . . . . .$.
Voltage on ALS, BLS . . . . . . . . . . . . . . . . . . . . . . . . . -1.0 V to +1.0 V
Voltage on AHB, BHB $\ldots \ldots . \mathrm{V}_{\text {AHS }}$, $\mathrm{BHS}+5 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{AHS}}$, $\mathrm{BHS}+15 \mathrm{~V}$ Input Current, HDEL and LDEL . . . . . . . . . . . . . . . . $-500 \mu \mathrm{~A}$ to $-50 \mu \mathrm{~A}$ Operating Ambient Temperature Range . . . . . . . . . . . $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$

## Thermal Information

| Thermal Resistance (Typical, Note 1) | $\theta_{\mathrm{JA}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ |
| :---: | :---: |
| SOIC Package | 85 |
| DIP Package | 75 |
| Storage Temperature Range | . $65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ |
| Operating Max. Junction Temperature | $.125^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering 10s)). (For SOIC - Lead Tips Only | $.300^{\circ} \mathrm{C}$ |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.
NOTE:

1. $\theta_{J A}$ is measured with the component mounted on an evaluation PC board in free air.

Electrical Specifications $\quad V_{D D}=V_{C C}=V_{A H B}=V_{B H B}=12 \mathrm{~V}, \mathrm{~V}_{S S}=V_{A L S}=V_{B L S}=V_{A H S}=V_{B H S}=0 \mathrm{~V}, R_{H D E L}=R_{\text {LDEL }}=100 \mathrm{~K}$ and $T_{A}=25^{\circ} \mathrm{C}$, Unless Otherwise Specified

| PARAMETER | SYMBOL | TEST CONDITIONS | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{JS}}=-40^{\circ} \mathrm{C} \text { TO } \\ 125^{\circ} \mathrm{C} \end{gathered}$ |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | MAX |  |
| SUPPLY CURRENTS AND CHARGE PUMPS |  |  |  |  |  |  |  |  |
| $\mathrm{V}_{\text {DD }}$ Quiescent Current | $\mathrm{I}_{\mathrm{DD}}$ | All inputs = 0V | 8.5 | 10.5 | 14.5 | 7.5 | 14.5 | mA |
| $\mathrm{V}_{\mathrm{DD}}$ Operating Current | $\mathrm{I}_{\text {DDO }}$ | Outputs switching $\mathrm{f}=500 \mathrm{kHz}$ | 9.5 | 12.5 | 15.5 | 8.5 | 15.5 | mA |
| $\mathrm{V}_{\text {CC }}$ Quiescent Current | $I_{\text {cc }}$ | All Inputs $=0 \mathrm{~V}, \mathrm{I}_{\mathrm{ALO}}=\mathrm{I}_{\mathrm{BLO}}=0$ | - | 0.1 | 10 | - | 20 | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\text {CC }}$ Operating Current | $\mathrm{I}_{\mathrm{CCO}}$ | $\mathrm{f}=500 \mathrm{kHz}$, No Load | 1 | 1.25 | 2.0 | 0.8 | 3 | mA |
| AHB, BHB Quiescent Current Qpump Output Current | $\mathrm{I}_{\text {AHB }}, \mathrm{I}_{\mathrm{BHB}}$ | $\begin{aligned} & \text { All Inputs }=0 \mathrm{~V}, \mathrm{I}_{\mathrm{AHO}}=\mathrm{I}_{\mathrm{BHO}}=0 \\ & \mathrm{~V}_{\mathrm{DD}}=\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{AHB}}=\mathrm{V}_{\mathrm{BHB}}=10 \mathrm{~V} \end{aligned}$ | -50 | -30 | -11 | -60 | -10 | $\mu \mathrm{A}$ |
| AHB, BHB Operating Current | $\mathrm{I}_{\text {AHBO }}, \mathrm{I}_{\text {BHBO }}$ | $\mathrm{f}=500 \mathrm{kHz}$, No Load | 0.6 | 1.2 | 1.5 | 0.5 | 1.9 | mA |
| AHS, BHS, AHB, BHB Leakage Current | $\mathrm{I}_{\mathrm{HLK}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{BHS}}=\mathrm{V}_{\mathrm{AHS}}=80 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{AHB}}=\mathrm{V}_{\mathrm{BHB}}=93 \mathrm{~V} \end{aligned}$ | - | 0.02 | 1.0 | - | 10 | $\mu \mathrm{A}$ |
| AHB-AHS, BHB-BHS Qpump Output Voltage | $\begin{aligned} & \hline \mathrm{V}_{\mathrm{AHB}}-\mathrm{V}_{\mathrm{AHS}} \\ & \mathrm{~V}_{\mathrm{BHB}}-\mathrm{V}_{\mathrm{BHS}} \end{aligned}$ | $\mathrm{I}_{\text {AHB }}=\mathrm{I}_{\text {AHB }}=0$, No Load | 11.5 | 12.6 | 14.0 | 10.5 | 14.5 | V |
| INPUT PINS: ALI, BLI, AHI, BHI, AND DIS |  |  |  |  |  |  |  |  |
| Low Level Input Voltage | $\mathrm{V}_{\mathrm{IL}}$ | Full Operating Conditions | - | - | 1.0 | - | 0.8 | V |
| High Level Input Voltage | $\mathrm{V}_{\mathrm{IH}}$ | Full Operating Conditions | 2.5 | - | - | 2.7 | - | V |
| Input Voltage Hysteresis |  |  | - | 35 | - | - | - | mV |
| Low Level Input Current | $\mathrm{I}_{\text {IL }}$ | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$, Full Operating Conditions | -130 | -100 | -75 | -135 | -65 | $\mu \mathrm{A}$ |
| High Level Input Current | $\mathrm{IIH}^{\text {I }}$ | $\mathrm{V}_{\mathrm{IN}}=5 \mathrm{~V}$, Full Operating Conditions | -1 | - | +1 | -10 | +10 | $\mu \mathrm{A}$ |
| TURN-ON DELAY PINS: LDEL AND HDEL |  |  |  |  |  |  |  |  |
| LDEL, HDEL Voltage | $\mathrm{V}_{\text {HDEL }}, \mathrm{V}_{\text {LDEL }}$ | $\mathrm{I}_{\text {HDEL }}=\mathrm{I}_{\text {LDEL }}=-100 \mu \mathrm{~A}$ | 4.9 | 5.1 | 5.3 | 4.8 | 5.4 | V |
| GATE DRIVER OUTPUT PINS: ALO, BLO, AHO, AND BHO |  |  |  |  |  |  |  |  |
| Low Level Output Voltage | $\mathrm{V}_{\text {OL }}$ | $\mathrm{I}_{\text {OUT }}=100 \mathrm{~mA}$ | 0.7 | 0.85 | 1.0 | 0.5 | 1.1 | V |
| High Level Output Voltage | $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{l}_{\text {OUT }}=-100 \mathrm{~mA}$ | 0.8 | 0.95 | 1.1 | 0.5 | 1.2 | V |
| Peak Pullup Current | $\mathrm{l}^{+}$ | $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ | 1.7 | 2.6 | 3.8 | 1.4 | 4.1 | A |

HIP4081A
Electrical Specifications $\quad V_{D D}=V_{C C}=V_{A H B}=V_{B H B}=12 \mathrm{~V}, \mathrm{~V}_{S S}=V_{A L S}=V_{B L S}=V_{A H S}=V_{B H S}=0 V, R_{H D E L}=R_{L D E L}=100 \mathrm{~K}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, Unless Otherwise Specified (Continued)

| PARAMETER | SYMBOL | TEST CONDITIONS | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{JS}}=-40^{\circ} \mathrm{C} \text { TO } \\ 125^{\circ} \mathrm{C} \end{gathered}$ |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | MAX |  |
| Peak Pulldown Current | $\mathrm{I}_{0}$ | $\mathrm{V}_{\text {OUT }}=12 \mathrm{~V}$ | 1.7 | 2.4 | 3.3 | 1.3 | 3.6 | A |
| Undervoltage, Rising Threshold | UV+ |  | 8.1 | 8.8 | 9.4 | 8.0 | 9.5 | V |
| Undervoltage, Falling Threshold | UV- |  | 7.6 | 8.3 | 8.9 | 7.5 | 9.0 | V |
| Undervoltage, Hysteresis | HYS |  | 0.25 | 0.4 | 0.65 | 0.2 | 0.7 | V |

Switching Specifications $\quad V_{D D}=V_{C C}=V_{A H B}=V_{B H B}=12 \mathrm{~V}, V_{S S}=V_{A L S}=V_{B L S}=V_{A H S}=V_{B H S}=0 V, R_{H D E L}=R_{L D E L}=10 K$, $C_{L}=1000 \mathrm{pF}$.

| PARAMETER | SYMBOL | TEST CONDITIONS | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ |  |  | $\begin{gathered} \mathrm{T}_{\mathrm{JS}}=-40^{\circ} \mathrm{C} \\ \mathrm{TO} 125^{\circ} \mathrm{C} \end{gathered}$ |  | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | MIN | TYP | MAX | MIN | MAX |  |
| Lower Turn-off Propagation Delay (ALI-ALO, BLI-BLO) | T ${ }_{\text {LPHL }}$ |  | - | 30 | 60 | - | 80 | ns |
| Upper Turn-off Propagation Delay (AHI-AHO, BHI-BHO) | $\mathrm{T}_{\text {HPHL }}$ |  | - | 35 | 70 | - | 90 | ns |
| Lower Turn-on Propagation Delay (ALI-ALO, BLI-BLO) | T LPLH | $\mathrm{R}_{\text {HDEL }}=\mathrm{R}_{\text {LDEL }}=10 \mathrm{~K}$ | - | 45 | 70 | - | 90 | ns |
| Upper Turn-on Propagation Delay (AHI-AHO, BHI-BHO) | $\mathrm{T}_{\text {HPLH }}$ | $\mathrm{R}_{\text {HDEL }}=\mathrm{R}_{\text {LDEL }}=10 \mathrm{~K}$ | - | 60 | 90 | - | 110 | ns |
| Rise Time | $\mathrm{T}_{\mathrm{R}}$ |  | - | 10 | 25 | - | 35 | ns |
| Fall Time | $\mathrm{T}_{\mathrm{F}}$ |  | - | 10 | 25 | - | 35 | ns |
| Turn-on Input Pulse Width | $\mathrm{T}_{\text {PWIN-ON }}$ | $\mathrm{R}_{\text {HDEL }}=\mathrm{R}_{\text {LDEL }}=10 \mathrm{~K}$ | 50 | - | - | 50 | - | ns |
| Turn-off Input Pulse Width | TPWIN-OFF | $\mathrm{R}_{\text {HDEL }}=\mathrm{R}_{\text {LDEL }}=10 \mathrm{~K}$ | 40 | - | - | 40 | - | ns |
| Turn-on Output Pulse Width | TPWOUT-ON | $\mathrm{R}_{\text {HDEL }}=\mathrm{R}_{\text {LDEL }}=10 \mathrm{~K}$ | 40 | - | - | 40 | - | ns |
| Turn-off Output Pulse Width | TPWOUT-OFF | $\mathrm{R}_{\text {HDEL }}=\mathrm{R}_{\text {LDEL }}=10 \mathrm{~K}$ | 30 | - | - | 30 | - | ns |
| Disable Turn-off Propagation Delay (DIS - Lower Outputs) | T ${ }_{\text {DISLOW }}$ |  | - | 45 | 75 | - | 95 | ns |
| Disable Turn-off Propagation Delay (DIS - Upper Outputs) | $\mathrm{T}_{\text {DISHIGH }}$ |  | - | 55 | 85 | - | 105 | ns |
| Disable to Lower Turn-on Propagation Delay (DIS - ALO and BLO) | $\mathrm{T}_{\text {DLPLH }}$ |  | - | 40 | 70 | - | 90 | ns |
| Refresh Pulse Width (ALO and BLO) | TREF-PW |  | 240 | 410 | 550 | 200 | 600 | ns |
| Disable to Upper Enable (DIS - AHO and BHO) | T UEN |  | - | 450 | 620 | - | 690 | ns |

TRUTH TABLE

| INPUT |  | OUTPUT |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| ALI, BLI | AHI, BHI | U/V | DIS | ALO, BLO | AHO, BHO |
| $X$ | X | X | 1 | 0 | 0 |
| 1 | X | 0 | 0 | 1 | 0 |
| 0 | 1 | 0 | 0 | 0 | 1 |
| 0 | 0 | 0 | 0 | 0 | 0 |
| X | X | 1 | X | 0 | 0 |

NOTE: X signifies that input can be either a " 1 " or " 0 ".

## Pin Descriptions

| PIN <br> NUMBER | SYMBOL | DESCRIPTION |
| :---: | :---: | :---: |
| 1 | BHB | B High-side Bootstrap supply. External bootstrap diode and capacitor are required. Connect cathode of bootstrap diode and positive side of bootstrap capacitor to this pin. Internal charge pump supplies $30 \mu \mathrm{~A}$ out of this pin to maintain bootstrap supply. Internal circuitry clamps the bootstrap supply to approximately 12.8 V . |
| 2 | BHI | B High-side Input. Logic level input that controls BHO driver (Pin 20). BLI (Pin 5) high level input overrides BHI high level input to prevent half-bridge shoot-through, see Truth Table. DIS (Pin 3) high level input overrides BHI high level input. The pin can be driven by signal levels of 0 V to 15 V (no greater than $\mathrm{V}_{\mathrm{DD}}$ ). |
| 3 | DIS | DISable input. Logic level input that when taken high sets all four outputs low. DIS high overrides all other inputs. When DIS is taken low the outputs are controlled by the other inputs. The pin can be driven by signal levels of 0 V to 15 V (no greater than $\mathrm{V}_{\mathrm{DD}}$ ). |
| 4 | $\mathrm{V}_{\text {SS }}$ | Chip negative supply, generally will be ground. |
| 5 | BLI | B Low-side Input. Logic level input that controls BLO driver (Pin 18). If BHI (Pin 2) is driven high or not connected externally then BLI controls both BLO and BHO drivers, with dead time set by delay currents at HDEL and LDEL (Pin 8 and 9). DIS (Pin 3) high level input overrides BLI high level input. The pin can be driven by signal levels of 0V to 15V (no greater than $\mathrm{V}_{\mathrm{DD}}$ ). |
| 6 | ALI | A Low-side Input. Logic level input that controls ALO driver (Pin 13). If AHI (Pin 7) is driven high or not connected externally then ALI controls both ALO and AHO drivers, with dead time set by delay currents at HDEL and LDEL (Pin 8 and 9). DIS (Pin 3) high level input overrides ALI high level input. The pin can be driven by signal levels of 0V to 15V (no greater than $\mathrm{V}_{\mathrm{DD}}$ ). |
| 7 | AHI | A High-side Input. Logic level input that controls AHO driver (Pin 11). ALI (Pin 6) high level input overrides AHI high level input to prevent half-bridge shoot-through, see Truth Table. DIS (Pin 3) high level input overrides AHI high level input. The pin can be driven by signal levels of 0 V to 15 V (no greater than $\mathrm{V}_{\mathrm{DD}}$ ). |
| 8 | HDEL | High-side turn-on DELay. Connect resistor from this pin to $\mathrm{V}_{\mathrm{SS}}$ to set timing current that defines the turn-on delay of both high-side drivers. The low-side drivers turn-off with no adjustable delay, so the HDEL resistor guarantees no shoot-through by delaying the turn-on of the high-side drivers. HDEL reference voltage is approximately 5.1 V . |
| 9 | LDEL | Low-side turn-on DELay. Connect resistor from this pin to $\mathrm{V}_{\mathrm{SS}}$ to set timing current that defines the turn-on delay of both low-side drivers. The high-side drivers turn-off with no adjustable delay, so the LDEL resistor guarantees no shoot-through by delaying the turn-on of the low-side drivers. LDEL reference voltage is approximately 5.1 V . |
| 10 | AHB | A High-side Bootstrap supply. External bootstrap diode and capacitor are required. Connect cathode of bootstrap diode and positive side of bootstrap capacitor to this pin. Internal charge pump supplies $30 \mu \mathrm{~A}$ out of this pin to maintain bootstrap supply. Internal circuitry clamps the bootstrap supply to approximately 12.8 V . |
| 11 | AHO | A High-side Output. Connect to gate of A High-side power MOSFET. |
| 12 | AHS | A High-side Source connection. Connect to source of A High-side power MOSFET. Connect negative side of bootstrap capacitor to this pin. |
| 13 | ALO | A Low-side Output. Connect to gate of A Low-side power MOSFET. |
| 14 | ALS | A Low-side Source connection. Connect to source of A Low-side power MOSFET. |
| 15 | $\mathrm{V}_{\mathrm{CC}}$ | Positive supply to gate drivers. Must be same potential as $\mathrm{V}_{\mathrm{DD}}$ (Pin 16). Connect to anodes of two bootstrap diodes. |
| 16 | $\mathrm{V}_{\mathrm{DD}}$ | Positive supply to lower gate drivers. Must be same potential as $\mathrm{V}_{C C}$ (Pin 15). De-couple this pin to $\mathrm{V}_{\text {SS }}$ (Pin 4). |
| 17 | BLS | B Low-side Source connection. Connect to source of B Low-side power MOSFET. |
| 18 | BLO | B Low-side Output. Connect to gate of B Low-side power MOSFET. |
| 19 | BHS | B High-side Source connection. Connect to source of B High-side power MOSFET. Connect negative side of bootstrap capacitor to this pin. |
| 20 | BHO | B High-side Output. Connect to gate of B High-side power MOSFET. |

## Timing Diagrams



FIGURE 1. INDEPENDENT MODE


FIGURE 2. BISTATE MODE


FIGURE 3. DISABLE FUNCTION



FIGURE 4. QUIESCENT $I_{D D}$ SUPPLY CURRENT vs $V_{D D}$ SUPPLY VOLTAGE


FIGURE 6. SIDE A, B FLOATING SUPPLY BIAS CURRENT vs FREQUENCY (LOAD = 1000pF)


FIGURE 8. $\mathrm{I}_{\mathrm{AHB}}, \mathrm{I}_{\mathrm{BHB}}$, NO-LOAD FLOATING SUPPLY BIAS CURRENT vs FREQUENCY


FIGURE 5. $I_{D D O}$, NO-LOAD $I_{D D}$ SUPPLY CURRENT vs


FIGURE 7. $I_{\text {CCO }}$, NO-LOAD $I_{C C}$ SUPPLY CURRENT vs FREQUENCY (kHz) TEMPERATURE


FIGURE 9. ALI, BLI, AHI, BHI LOW LEVEL INPUT CURRENT IIL vs TEMPERATURE

Typical Performance Curves $\mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{AHB}}=\mathrm{V}_{\mathrm{BHB}}=12 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=\mathrm{V}_{\mathrm{ALS}}=\mathrm{V}_{\mathrm{BLS}}=\mathrm{V}_{\mathrm{AHS}}=\mathrm{V}_{\mathrm{BHS}}=0 \mathrm{~V}, \mathrm{R}_{\mathrm{HDEL}}=\mathrm{R}_{\mathrm{LDEL}}=10 \mathrm{~K}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, Unless Otherwise Specified


FIGURE 10. AHB - AHS, BHB - BHS NO-LOAD CHARGE PUMP VOLTAGE vs TEMPERATURE


FIGURE 12. DISABLE TO UPPER ENABLE, TUEN, PROPAGATION DELAY vs TEMPERATURE


FIGURE 14. $T_{\text {REF-PW }}$ REFRESH PULSE WIDTH vs TEMPERATURE


FIGURE 11. UPPER DISABLE TURN-OFF PROPAGATION DELAY TIISHIGH vs TEMPERATURE


FIGURE 13. LOWER DISABLE TURN-OFF PROPAGATION DELAY T dIsLow vs TEMPERATURE


FIGURE 15. DISABLE TO LOWER ENABLE TDLPLH PROPAGATION DELAY vs TEMPERATURE

Typical Performance Curves $\mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\text {AHB }}=\mathrm{V}_{\text {BHB }}=12 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=\mathrm{V}_{\mathrm{ALS}}=\mathrm{V}_{\mathrm{BLS}}=\mathrm{V}_{\mathrm{AHS}}=\mathrm{V}_{B H S}=0 \mathrm{~V}$, $\mathrm{R}_{H D E L}=R_{\text {LDEL }}=10 \mathrm{~K}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, Unless Otherwise Specified (Continued)


FIGURE 16. UPPER TURN-OFF PROPAGATION DELAY $T_{\text {HPHL }}$ vs TEMPERATURE


FIGURE 18. LOWER TURN-OFF PROPAGATION DELAY TLPHL vs TEMPERATURE


FIGURE 20. GATE DRIVE FALL TIME $\mathrm{T}_{\mathrm{F}}$ vs TEMPERATURE


FIGURE 17. UPPER TURN-ON PROPAGATION DELAY $T_{H P L H}$ vs TEMPERATURE


FIGURE 19. LOWER TURN-ON PROPAGATION DELAY TLPLH TEMPERATURE


FIGURE 21. GATE DRIVE RISE TIME $T_{R}$ vs TEMPERATURE



FIGURE 22. V $_{\text {Ldel }}, \mathrm{V}_{\text {hdel }}$ VOLTAGE vs TEMPERATURE


FIGURE 24. LOW LEVEL OUTPUT VOLTAGE $V_{\text {OL }}$ vs BIAS SUPPLY AND TEMPERATURE AT 100 mA


FIGURE 26. PEAK PULLUP CURRENT $\mathrm{I}_{\mathrm{O}+}$ vs BIAS SUPPLY VOLTAGE


FIGURE 23. HIGH LEVEL OUTPUT VOLTAGE $\mathrm{V}_{\mathrm{CC}}-\mathrm{V}_{\mathrm{OH}}$ vs BIAS SUPPLY AND TEMPERATURE AT 100 mA


FIGURE 25. PEAK PULLDOWN CURRENT $I_{0}$ vs BIAS SUPPLY VOLTAGE


FIGURE 27. LOW VOLTAGE BIAS CURRENT IDD (LESS QUIESCENT COMPONENT) vs FREQUENCY AND GATE LOAD CAPACITANCE

Typical Performance Curves $\mathrm{V}_{\mathrm{DD}}=\mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{A H B}=\mathrm{V}_{\mathrm{BHB}}=12 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=\mathrm{V}_{\mathrm{ALS}}=\mathrm{V}_{\mathrm{BLS}}=\mathrm{V}_{\text {AHS }}=\mathrm{V}_{B H S}=0 \mathrm{~V}, \mathrm{R}_{\text {HDEL }}=\mathrm{R}_{\text {LDEL }}=$ 100 K and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, Unless Otherwise Specified (Continued)


FIGURE 28. HIGH VOLTAGE LEVEL-SHIFT CURRENT vs FREQUENCY AND BUS VOLTAGE


FIGURE 29. UNDERVOLTAGE LOCKOUT vs TEMPERATURE


FIGURE 30. MINIMUM DEAD-TIME vs DEL RESISTANCE


FIGURE 31. HIP4081A EVALUATION PC BOARD SCHEMATIC


FIGURE 32. HIP4081A EVALUATION BOARD SILKSCREEN

## Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to the web to make sure that you have the latest revision.

| DATE | REVISION |  |
| :---: | :--- | :--- |
| September 15, 2015 | FN3659.8 | Updated Ordering Information Table on page 1. <br> Added Revision History and About Intersil sections. <br> Updated POD M20.3 from rev 1 to rev 3. Changes since rev 1: <br> Top View: |
|  |  | Corrected "7.50 BSC" to "7.60/7.40" (no change from rev 2; error was introduced in conversion) <br> Changed "10.30 BSC" to "10.65/10.00" (no change from rev 2; error was introduced in conversion) <br> Side View: <br> Changed "12.80 BSC" to "13.00/12.60" (no change from rev 2; error was introduced in conversion) <br> Changed "2.65 max" to "2.65/2.35" (no change from rev 2; error was introduced in conversion) |
|  |  |  |
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|  |  |  |
|  |  |  |

## About Intersil

Intersil Corporation is a leading provider of innovative power management and precision analog solutions. The company's products address some of the largest markets within the industrial and infrastructure, mobile computing and high-end consumer markets.

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## Dual-In-Line Plastic Packages (PDIP)


-B-


NOTES:

1. Controlling Dimensions: INCH. In case of conflict between English and Metric dimensions, the inch dimensions control.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication No. 95.
4. Dimensions $A, A 1$ and $L$ are measured with the package seated in JEDEC seating plane gauge GS-3.
5. D, D1, and E1 dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.010 inch ( 0.25 mm ).
6. $E$ and $\mathrm{e}_{\mathrm{A}}$ are measured with the leads constrained to be perpendicular to datum $-\mathrm{C}-$.
7. $e_{B}$ and $e_{C}$ are measured at the lead tips with the leads unconstrained. $e_{C}$ must be zero or greater.
8. B1 maximum dimensions do not include dambar protrusions. Dambar protrusions shall not exceed 0.010 inch $(0.25 \mathrm{~mm})$.
9. N is the maximum number of terminal positions.
10. Corner leads (1, N, N/2 and N/2 + 1) for E8.3, E16.3, E18.3, E28.3, E42.6 will have a B1 dimension of 0.030-0.045 inch (0.76-1.14mm).

E20.3 (JEDEC MS-001-AD ISSUE D) 20 LEAD DUAL-IN-LINE PLASTIC PACKAGE

| SYMBOL | INCHES |  | MILLIMETERS |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  |
| A | - | 0.210 | - | 5.33 | 4 |
| A1 | 0.015 | - | 0.39 | - | 4 |
| A2 | 0.115 | 0.195 | 2.93 | 4.95 | - |
| B | 0.014 | 0.022 | 0.356 | 0.558 | - |
| B1 | 0.045 | 0.070 | 1.55 | 1.77 | 8 |
| C | 0.008 | 0.014 | 0.204 | 0.355 | - |
| D | 0.980 | 1.060 | 24.89 | 26.9 | 5 |
| D1 | 0.005 | - | 0.13 | - | 5 |
| E | 0.300 | 0.325 | 7.62 | 8.25 | 6 |
| E1 | 0.240 | 0.280 | 6.10 | 7.11 | 5 |
| e | 0.100 |  | BSC | 2.54 | BSC |
| $e_{\text {A }}$ | 0.300 |  | BSC | 7.62 | BSC |
| $e_{B}$ | - | 0.430 | - | 10.92 | 7 |
| L | 0.115 | 0.150 | 2.93 | 3.81 | 4 |
| N | 20 |  | 20 |  | 9 |

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## Package Outline Drawing

## M20.3

20 LEAD WIDE BODY SMALL OUTLINE PLASTIC PACKAGE (SOIC)
Rev 3, 2/11



SIDE VIEW


TYPICAL RECOMMENDED LAND PATTERN

NOTES:

1. Dimensioning and tolerancing per ASME Y14.5M-1994.
2. Dimension does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15 mm ( 0.006 inch) per side.
3. Dimension does not include interlead lash or protrusions. Interlead flash and protrusions shall not exceed 0.25 mm ( 0.010 inch ) per side.
4. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
5. Dimension is the length of terminal for soldering to a substrate.
6. Terminal numbers are shown for reference only.
7. The lead width as measured $0.36 \mathrm{~mm}(0.14 \mathrm{inch})$ or greater above the seating plane, shall not exceed a maximum value of 0.61 mm (0.024 inch)
8. Controlling dimension: MILLIMETER.
9. Dimensions in () for reference only.
10. JEDEC reference drawing number: MS-013-AC.

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